

1. DESCRIPTION

The 3232 series devices device consists of two line drivers, two line receivers, and a dual charge-pump circuit with 15-kV ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. The devices operate at data signaling rates up to 250 kbit/s and a maximum of 30-V/µs driver output slew rate.

2. FEATURES

- RS-232 Bus-Pin ESD Protection
 - ±15 kV Using Human-Body Model (HBM)
 - ±8kV (IEC6 1000-4-2, Contact Discharge)
 - ±15kV (IEC6 1000-4-2, Air Gap Discharge)
- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V VCC Supply
- Operates Up To 250 kbit/s
- Two Drivers and Two Receivers
- Low Supply Current: 300 μA (Typical)
- External Capacitors: 4 × 0.1 μF
- Accepts 5-V Logic Input With 3.3-V Supply

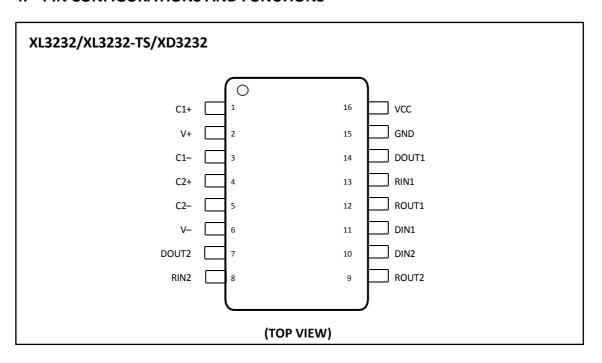
3. Applications

- Industrial PC
- Wired Networks
- Data Centre and Enterprise Networking
- Battery-Powered Systems
- PDAs
- Laptops
- Portable Computers
- Pocket PC
- Handheld Devices

www.xinluda.com 1 / 15 Rev 2.3



4. PIN CONFIGURATIONS AND FUNCTIONS

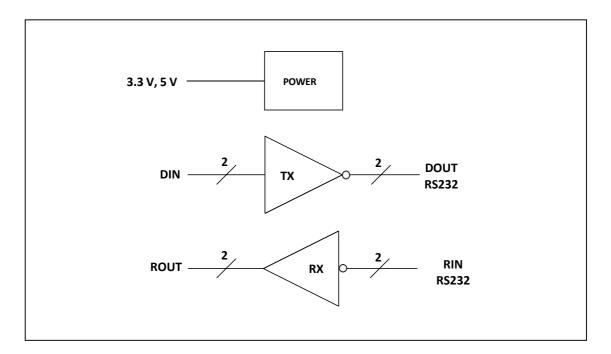


Pin Functions

| PIN | | | |
|----------|----|----------|---|
| NAME NO. | | 1/0 | DESCRIPTION |
| C1+ | 1 | _ | Positive lead of C1 capacitor |
| V+ | 2 | 0 | Positive charge pump output for storage capacitor only |
| C1 - | 3 | _ | Negative lead of C1 capacitor |
| C2+ | 4 | _ | Positive lead of C2 capacitor |
| C2 - | 5 | _ | Negative lead of C2 capacitor |
| V - | 6 | 0 | Negative charge pump output for storage capacitor only |
| DOUT2 | 7 | 0 | RS232 line data output (to remote RS232 system) |
| RIN2 | 8 | ı | RS232 line data input (from remote RS232 system) |
| ROUT2 | 9 | 0 | Logic data output (to UART) |
| DIN2 | 10 | ı | Logic data input (from UART) |
| DIN1 | 11 | ı | Logic data output (from UART) |
| ROUT1 | 12 | 0 | Logic data input (to UART) |
| RIN1 | 13 | ı | RS232 line data output (from remote RS232 system) |
| DOUT1 | 14 | 0 | RS232 line data input (to remote RS232 system) |
| GND | 15 | _ | Ground |
| VCC | 16 | <u> </u> | Supply Voltage, Connect to external 3-V to 5.5-V power supply |



5. FUNCTIONAL BLOCK DIAGRAM



Block Diagram

www.xinluda.com 3 / 15 Rev 2.3



6. SPECIFICATIONS

6.1. Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|---|--|-----------|-------|-----------------------|------|
| VCC | Supply voltage ⁽²⁾ | | - 0.3 | 6 | V |
| V+ | Positive output supply voltage(2) | | - 0.3 | 7 | V |
| V – Negative output supply voltage ⁽²⁾ | | | - 7 | 0.3 | V |
| V+ - V - | - V - Supply voltage difference ⁽²⁾ | | | 13 | V |
| | | Drivers | - 0.3 | 6 | V |
| Vı | Input voltage | Receivers | - 25 | 25 | V |
| | | Drivers | -13.2 | 13.2 | V |
| Vo | Output voltage | Receivers | - 0.3 | V _{CC} + 0.3 | V |
| Tı | Operating virtual junction temperature | | | 125 | °C |
| T _{Stg} | Storage temperature | | -45 | 150 | °C |

^[1] Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions.

If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime

6.2. Thermal Resistance Characteristics

| | THERMAL METRIC | | | XD (DIP) | UNIT |
|-------------------|--|---------|---------|----------|------|
| | | 16 PINS | 16 PINS | 16 PINS | |
| R _{e JA} | Junction-to-ambient thermal resistance | 85.9 | 103.1 | 66.6 | °C/W |
| R θ JCtop | Junction-to-case (top) thermal resistance | 43.1 | 49.2 | 32.4 | °C/W |
| R _{eJB} | Junction-to-board thermal resistance | 44.5 | 54.8 | 31.9 | °C/W |
| ψ , _т | Junction-to-top characterization parameter | 10.1 | 12 | 8.4 | °C/W |
| ψ јв | Junction-to-board characterization parameter | 44.1 | 54.1 | 31.5 | °C/W |
| R e JCbot | Junction-to-case (bottom) thermal resistance | N/A | N/A | N/A | °C/W |

6.3. ESD Ratings

| | | | VALUE | UNIT |
|--|---|---------|-------|------|
| V _(ESD) Electrostatic discharge | Human body model (HBM), per ANSI/ ESDA/JEDEC JS-001 | ±2000 | | |
| | RIN, DOUT and DOUT Pins $^{(1)}$ | ±15,000 | | |
| | Charged-device model (CDM), per JEDEC specification JESD22-C101 All other pins $^{(2)}$ | ±1500 | V | |
| | Charging Device Model (CDM), JEDEC Specification JESD22-C101, All Pins ⁽²⁾ | | | |

^[1] JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

www.xinluda.com 4 / 15 Rev 2.3

^[2] All voltages are with respect to network GND.

^[2] JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.4. Recommended Operating Conditions

See Figure 9-1.

| | | | | MIN | NOM | MAX | UNIT |
|----------------|---------------------------------|-------------|----------------------------|------|-----|-----|------|
| Vec | VCC Supply voltage - | | V _{CC} = 3.3V | 3 | 3.3 | 3.6 | V |
| VCC | | | V _{CC} = 5V | 4.5 | 5 | 5.5 | V |
| VIH | Driver high-level input voltage | DIN | V _{CC} = 3.3V | 2 | | | V |
| VIH | Driver nigh-level input voltage | | V _{cc} = 5V | 2.4 | | | |
| VIL | Driver low-level input voltage | DIN | | | | 0.8 | V |
| ,, | Driver input voltage | voltage DIN | | 0 | | 5.5 | ., |
| Vı | Receiver input voltage RIN | | | - 25 | | 25 | V |
| T _A | Operating free-air temperature | | XL3232、XL3232-TS XD3232 | - 40 | | 85 | °C |

^[1] Test conditions are C1–C4 = 0.1μ F (VCC = 3.3V ± 0.3 V); C1 = 0.047μ F, C2–C4 = 0.33μ F (VCC = 5V ± 0.5 V)

6.5. Electrical Characteristics - DEVICE(2)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

| PARAMETER | TEST CONDITIONS | MIN TYP ⁽²⁾ | MAX | UNIT |
|--------------------------------|---|------------------------|-----|------|
| I _{cc} Supply current | No load, V _{CC} = 3.3 V or 5 V | 0.5 | 10 | mA |

^[1] All typical values are at VCC = 3.3 V or VCC = 5 V, and TA = $25 ^{\circ}\text{C}$.

6.6. Electrical Characteristics -DRIVER(2)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

| PARAMETER | | TEST CONDITIONS | | MIN | TYP ⁽¹⁾ | MAX | UNIT |
|--------------------------------|------------------------------|---|-----------------|-----|--------------------|-----|------|
| V _{OH} | High-level output voltage | DOUT at R_L = 3 $k\Omega$ to GND, | DIN = GND | 5 | 5.4 | | ٧ |
| V _{OL} | Low-level output voltage | DOUT at R_L = 3 $k\Omega$ to $\mbox{DIN} = \mbox{V}_{CC} \label{eq:DIN}$ GND, | | - 5 | - 5.4 | | ٧ |
| I _{IH} | High-level input current | $V_{I} = V_{CC}$ | | | ±0.01 | ±1 | μА |
| I _{IL} | Low-level input current | V _I at GN | D | | ±0.01 | ±1 | μА |
| I _{OS} ⁽²⁾ | | V _{CC} = 3.6 V, | $V_0 = 0 V$ | | | | |
| 'os '-' | Short-circuit output current | V _{cc} = 5.5 V, | $V_0 = 0 V$ | | ±35 | ±60 | mA |
| r _o | Output resistance | V_{CC} , V+, and V - = 0 V, | $V_0 = \pm 2 V$ | 300 | 10M | | Ω |

^[1] All typical values are at VCC = 3.3 V or VCC = 5 V, and TA = 25°C.

www.xinluda.com 5 / 15 Rev 2.3

^[2] Test conditions are C1–C4 = 0.1 μ F at VCC = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at VCC = 5 V ± 0.5 V.

^[2] Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

Test conditions are C1–C4 = 0.1 μ F at VCC = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at VCC = 5 V \pm 0.5 V.



6.7. Electrical Characteristics - RECEIVER

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

| | PARAMETER | TEST CONDITIONS | MIN | TYP ⁽¹⁾ | MAX | UNIT | |
|---------------------------------|--|--------------------------------|-----------------------|-----------------------|-----|----------|--|
| V _{OH} | High-level output voltage | $I_{OH} = -1 \text{ mA}$ | V _{cc} - 0.6 | V _{cc} - 0.1 | | ٧ | |
| V _{OL} | Low-level output voltage | I _{OL} = 1.6 mA | | | 0.4 | ٧ | |
| V _{IT+} Positive-going | Positive-going input threshold voltage | $V_{CC} = 3.3 \text{ V}$ | | 1.5 | 2.4 | V | |
| | Positive-going input timeshold voltage | V _{CC} = 5 V | | 1.8 | 2.4 | | |
| V _{IT} - | Negative-going input threshold voltage | $V_{CC} = 3.3 \text{ V}$ | 0.6 | 1.2 | | V | |
| VIT - | Negative-going input threshold voltage | V _{CC} = 5 V | 0.8 | 1.5 | | V | |
| V_{hys} | Input hysteresis ($V_{IT+} - V_{IT-}$) | | | | 0.3 | V | |
| ri | Input resistance | V _I = ±3 V to ±25 V | 3 | 5 | 7 | kΩ | |

^[1] All typical values are at VCC = 3.3 V or VCC = 5 V, and TA = 25°C .

6.8. Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

| | PARAMETER | TEST CONDITIONS | | | TYP ⁽²⁾ | MAX | UNIT |
|--------|---|---|---------------------------------|-----|--------------------|-----|--------|
| | Maximum data rate | RL = $3 \text{ k}\Omega$, One DOUT switching, | CL = 1000 pF, see Figure 7-1 | 150 | 250 | | kbit/s |
| tsk(p) | Driver pulse skew(3) | RL = 3 kΩ to 7 kΩ, see Figure 7-2 | CL = 150 pF to 2500 pF, | | 300 | | ns |
| | Driver slew rate, transition region | RI = 3 kO to 7 kO. VCC = 3.3 | CL = 150 pF to 1000 pF | 6 | | 30 | |
| SR(tr) | | V | CL = 150 pF to 2500 pF | 4 | | 30 | V/µs |
| tPLH | Receiver propagation delay time, low- to high-level output | CI - 1 | 150.55 | | 300 | | ns |
| tPHL | Receiver propagation delay time, high- to low-level output | CL = 150 pF, see Figure 7-3 | | | 300 | | ns |
| tsk(p) | Receiver pulse skew ⁽³⁾ | | | | 300 | | ns |

^[1] All typical values are at Vcc = 3.3 V or Vcc = 5 V, and TA = 25°C.

www.xinluda.com 6 / 15 Rev 2.3

Test conditions are C1–C4 = 0.1 μ F at VCC = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at VCC = 5 V \pm 0.5 V.

^[2] Pulse skew is defined as |tPLH - tPHL| of each channel of the same device.

Test conditions are C1–C4 = 0.1 μ F at Vcc = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at Vcc = 5 V \pm 0.5 V.



6.9. Typical Characteristics

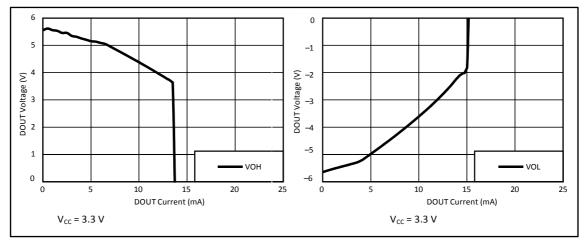


Figure 6-1. DOUT VOH vs Load Current, Both Drivers Loaded

Figure 6-2. DOUT VOL vs Load Current, Both Drivers Loaded

7. Parameter Measurement Information

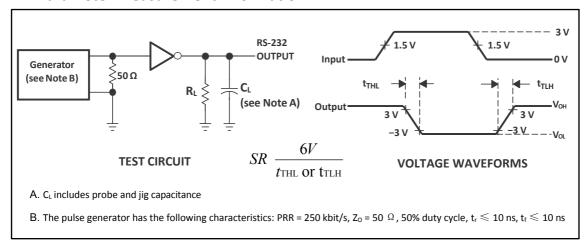


Figure 7-1. Driver Slew Rate

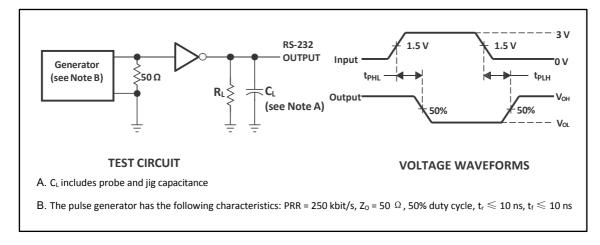


Figure 7-2. Driver Pulse Skew

www.xinluda.com 7 / 15 Rev 2.3



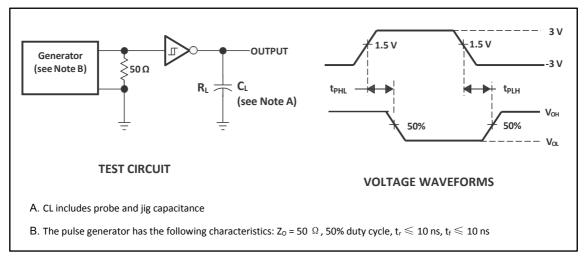


Figure 7-3. Receiver Propagation Delay Times

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8. Detailed Description

8.1. Overview

The 3232 series devices consists of two line drivers, two-line receivers, and a dual charge-pump circuit with IEC61000-4-2 ESD protection terminal to terminal (serial-port connection terminals, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. The device operates at data signaling rates up to 250 kbit/s and a maximum of 30-V/µs driver output slew rate. Outputs are protected against shorts to ground.

8.2. Feature Description

8.2.1. Power

The power block increases, inverts, and regulates voltage at V+ and V- pins using a charge pump that requires four external capacitors.

8.2.2. RS232 Driver

Two drivers interface standard logic level to RS232 levels. Both DIN inputs must be valid high or low.

8.2.3. RS232 Receiver

Two receivers interface RS232 levels to standard logic levels. An open input will result in a high output on ROUT. Each RIN input includes an internal standard RS232 load.

8.3. Device Functional Modes

Table 8-1 and Talbe 8-2 list the functional modes of the drivers and receivers of 3232.

Table 8-1. Each Driver(1)

| INPUT DIN | OUTPUT DOUT |
|-----------|-------------|
| L | Н |
| Н | L |

[1] H = high level, L = low level

Table 8-2. Each Receiver⁽¹⁾

| INPUT RIN | OUTPUT ROUT |
|-----------|-------------|
| L | Н |
| Н | L |
| Open | Н |

[1] H = high level, L = low level,

Open = input disconnected or connected driver off

8.3.1. VCC Powered by 3 V to 5.5 V

The device is in normal operation.

8.3.2. VCC Unpowered, VCC = 0 V

When 3232 is unpowered, it can be safely connected to an active remote RS232 device.

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9. Application and Implementation

9.1. Application Information

For proper operation, add capacitors as shown in Figure 9-1.

9.2. Typical Application

ROUT and DIN connect to UART or general-purpose logic lines. RIN and DOUT lines connect to a RS232 connector or cable.

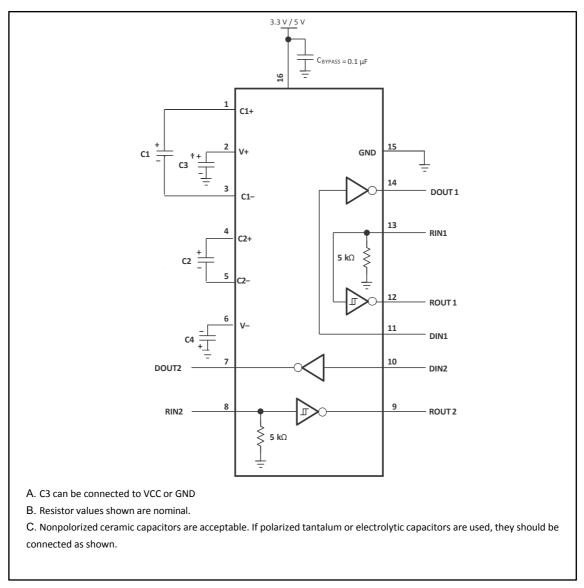


Figure 9-1. Typical Operating Circuit and Capacitor Values

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9.2.1. Design Requirements

The recommended VCC is 3.3~V or 5~V. 3~V to 5.5~V is also possible The maximum recommended bit rate is 250~kbit/s.

9.2.2. Detailed Design Procedure

All DIN inputs must be connected to valid low or high logic levels. Select capacitor values based on VCC level for best performance.

9.2.3. Application Curve

Figure 9-2 curves are for 3.3-V VCC and 250-kbit/s alternative bit data stream.

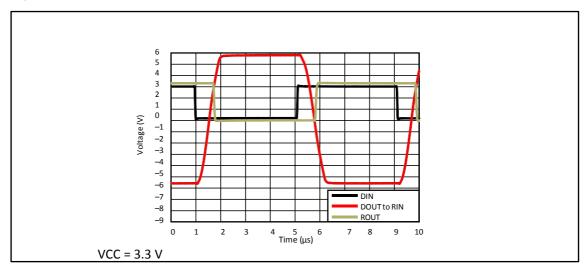


Figure 9-2. 250 kbit/s Driver to Receiver Loopback Timing Waveform

10. Power Supply Recommendations

The supply voltage, VCC, should be between 3 V and 5.5 V. Select the values of the charge-pump capacitors using Table 9-1.

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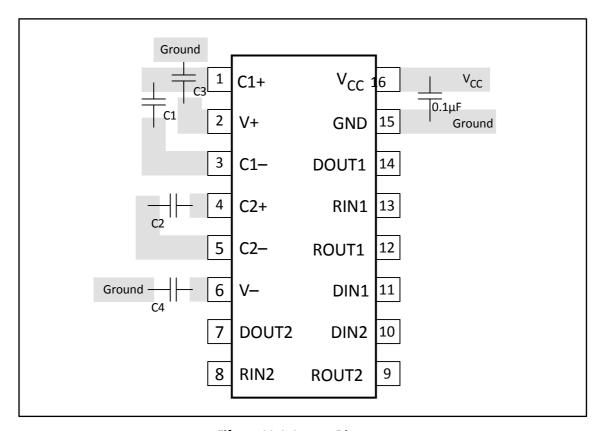


11. Layout

11.1. Layout Guidelines

Keep the external capacitor traces short, specifically on the C1 and C2 nodes that have the fastest rise and fall times.

11.2. Layout Example



Fifgure 11-1. Layout Diagram

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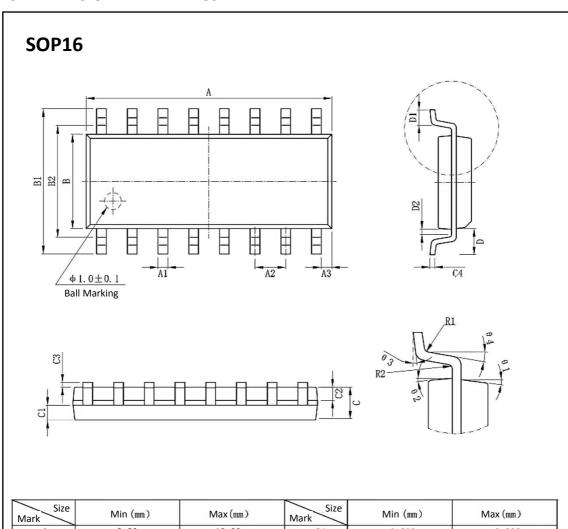


12. ORDERING INFORMATION

Ordering Information

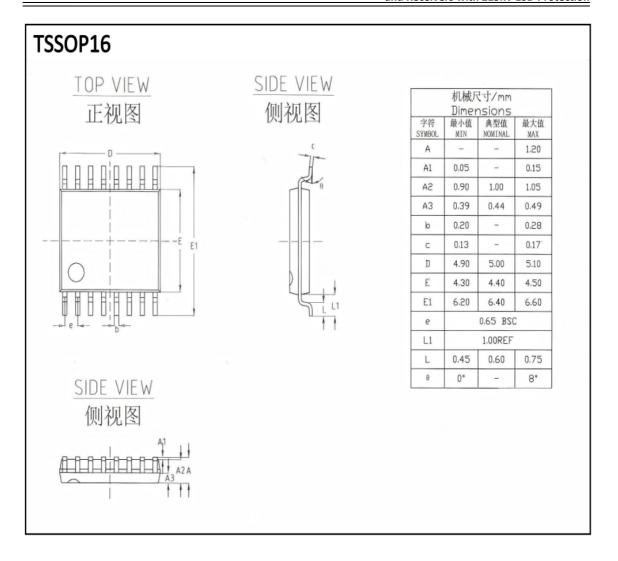
| Part Number | Device Marking | Package Type | Body size (mm) | Temperature (°C) | MSL | Transport Media | Package Quantity |
|----------------|-------------------|-----------------|-------------------|---------------------|------|--------------------|---------------------|
| XL3232 | XL3232 | SOP16 | 10.00 * 3.95 | - 40 to 85 | MSL3 | T&R | 2500 |
| XL3232-TS | XL3232-TS | TSSOP16 | 5.00 * 4.40 | - 40 to 85 | MSL3 | T&R | 2500 |
| XD3232 | XD3232 | DIP16 | 19.05 * 6.35 | - 40 to 85 | MSL3 | Tube 25 | 1000 |

13. DIMENSIONAL DRAWINGS



| Size Mark | Min (mm) | Max(mm) | Mark | Min (mm) | Max(mm) |
|--------------|----------|---------|------|---------------|---------|
| A | 9. 80 | 10.00 | C4 | 0. 203 | 0. 233 |
| A1 | 0, 356 | 0.456 | D | 1. 05TYP | |
| Λ2 | 1. 27TYP | | D1 | 0.40 | 0. 70 |
| A3 | 0. 3 | 02TYΓ | D2 | 0. 15 0. 25 | |
| В | 3, 85 | 3, 95 | R1 | 0. 20TYP | |
| B1 | 5.84 | 6. 24 | R2 | 0. 20TYP | |
| B2 | 5. 00TYP | | θ 1 | 8° ∼ 12° TYP4 | |
| С | 1. 40 | 1. 60 | θ 2 | 8° ∼ 12° TYP4 | |
| C1 | 0. 61 | 0.71 | 0 3 | 0° ~ 8° | |
| C2 | 0, 54 | 0.64 | 0 4 | 4° ∼ 12° | |
| C3 | 0. 05 | 0. 25 | | | |





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